



Product Change Notification

106427 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 106427 - 00
Change Title: SC5400, PCN 106427-00, Product Design, Class 2, Thermal Sensor Reliability
Date of Publication: June 14, 2006

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 23, 2006
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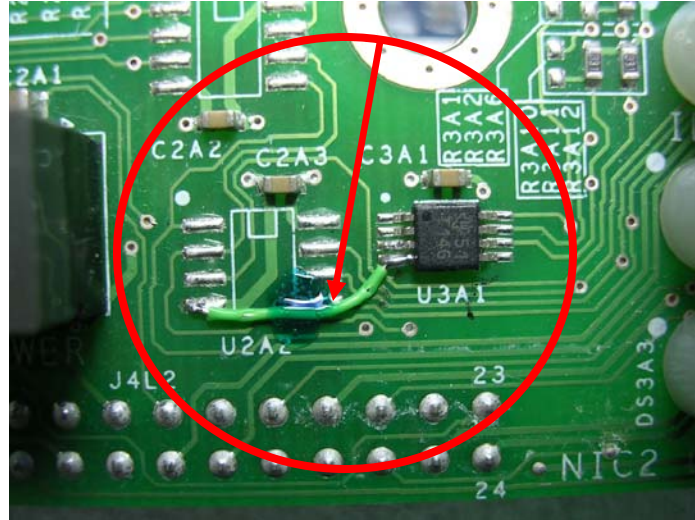
Description of Change to the Customer:

A wire is being added to the front panel board to increase reliability of the front panel thermal sensor. The wire will run between pin4 of U3A1 and GND.

Wide View:



Close-up View:



Customer Impact of Change and Recommended Action:

Intel does not anticipate any adverse customer impact to these changes. Intel recommends performing a standard level of evaluation as updated product becomes available.

Products Affected / Intel Ordering Codes:

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA	Pre-Change Subassembly	Post-Change Subassembly
ARIG2PMKIT	878328	878328	D33872-001	D33872-002	D23493-302	D23493-303
SC5400BASE	877757	877757	D33731-001	D33731-002	D23493-302	D23493-303
SC5400BASENA	881189	881189	D33731-001	D33731-002	D23493-302	D23493-303
SC5400BRP	877804	877804	D33733-001	D33733-002	D23493-302	D23493-303
SC5400BRPNA	880615	880615	D33733-001	D33733-002	D23493-302	D23493-303
SC5400LX	877844	877844	D33732-001	D33732-002	D23493-302	D23493-303
SC5400LXNA	880322	880322	D33732-001	D33732-002	D23493-302	D23493-303

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

June 14, 2006

Revision Number:

00

Reason:

Originally Published PCN